

FF1 thru FF7

Surface Mount Glass Passivated Fast Recovery Rectifier Reverse Voltage 50~1000V Forward Current 1A

Features

- · Glass passivated Fast Recovery rectifiers
- Very low profile typical height of 1.0 mm
- Low forward voltage drop
- · Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- AEC-Q101 qualified
- High temperature soldering guaranteed: 260°C/10 seconds
- Halogen-free according to IEC 61249-2-21 definition







eSGA (SOD-123FL)

Typical Applications

For use of general purpose rectification in lighting, cellular phone, portable device, power supplies and other consumer applications.

| Maximum Ratings (TA = 25 °C unless otherwise noted) | | | | | | | | | |
|--|----------|---------------|-----|-----|-----|-----|-----|------|------|
| Parameter | Symbol | FF1 | FF2 | FF3 | FF4 | FF5 | FF6 | FF7 | Unit |
| Maximum repetitive peak reverse voltage | VRRM | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | VRMS | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC blocking voltage | VDC | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum average forward rectified current | IF(AV) | 1.0 | | | | Α | | | |
| Peak forward surge current 8.3 ms single half sine- wave superimposed on rated load | IFSM | 30 | | | Α | | | | |
| Operating junction and storage temperature range | TJ, TSTG | - 55 to + 150 | | | °C | | | | |

| Electrical Characteristics (TA = 25 °C unless otherwise noted) | | | | | | | | | | |
|--|--|-----------------|---------|-----|-----|-----|-----|-------|-----|------|
| Parameter | Test Conditions | Symbol | FF1 | FF2 | FF3 | FF4 | FF5 | FF6 | FF7 | Unit |
| Maximum instantaneous forward voltage | 1 A | V _F | 1.3 | | | | | Volts | | |
| Maximum DC reverse current at rated DC blocking voltage | TA=25°C TA=125°C | I _R | 5 50 | | | | | | μΑ | |
| Maximum reverse recovery time | I_F =0.5A, I_R =1.0A, I_{rr} =0.25A | t _{rr} | 150 | | | 250 | 500 | | nS | |
| Typical junction capacitance | 4.0 V, 1 MHz | CJ | 8.2 | | | | | pF | | |
| | juntion to ambient | $R_{\theta JA}$ | 76 | | | | | | | |
| Typical thermal resistance ¹⁾ | juntion to case | $R_{\theta JC}$ | 42 | | | | | | | °C/W |
| | juntion to mount | $R_{\theta JM}$ | 7 | | | | | | • | |

Note:1),The thermal resistance from junction to ambient,case or mount,mounted on P.C.B with 5x5mm copper pads,2 OZ,FR4 PCB



Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

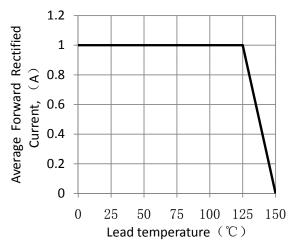


Figure 1. Forward Current Derating Curve

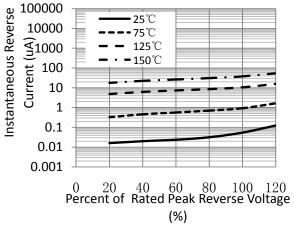


Figure 3. Typical Reverse Characteristics

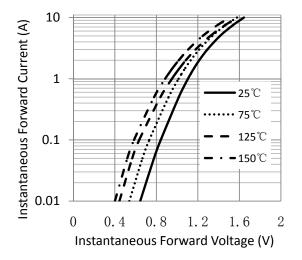


Figure 5. Typical Instantaneous Forward Characteristics

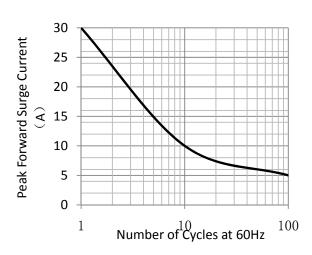


Figure 2.Maximum Non-Repetitive Peak Forward Surge Current

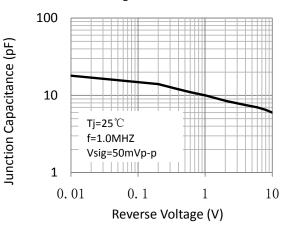
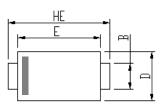
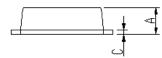


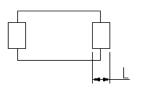
Figure 4. Typical Junction Capacitance

Package Outline Dimensions



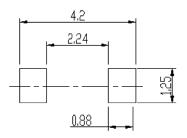






| DIM | Unit: | mm | Unit: inch | | | |
|-----|-------|------|------------|-------|--|--|
| | MIN | MAX | MIN | MAX | | |
| Α | 0.9 | 1.08 | 0.035 | 0.043 | | |
| A1 | 0 | 0.1 | 0.000 | 0.004 | | |
| В | 0.85 | 1.05 | 0.033 | 0.041 | | |
| С | 0.1 | 0.25 | 0.004 | 0.010 | | |
| D | 1.7 | 2 | 0.067 | 0.079 | | |
| Е | 2.9 | 3.1 | 0.114 | 0.122 | | |
| L | 0.43 | 0.83 | 0.017 | 0.033 | | |
| HE | 3.5 | 3.9 | 0.138 | 0.154 | | |

Soldering footprint

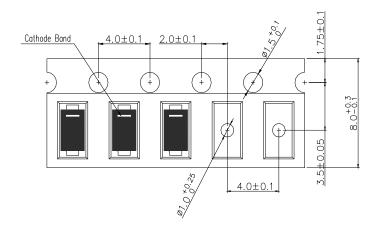


Packing Information

Packing quantities:

3000 pcs/Reel, 40 Reels/Box; 8mm Tape, 7" Reel

Tape & Reel Specification





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